United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/720,579	11/24/2003	Sangyum Kim	1772-5	5710
24106 7590 01/03/2008 EGBERT LAW OFFICES		EXAMINER		
412 MAIN ST	REET, 7TH FLOOR		WONG, EDNA	
HOUSTON, T	TON, TX 77002		ART UNIT	PAPER NUMBER
			1795	
			MAIL DATE	DELIVERY MODE
			01/03/2008	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

		Application No.	Applicant(s)		
Office Action Summary		10/720,579	KIM ET AL.		
		Examiner	Art Unit		
	,	Edna Wong	1795		
- The MAILING DATE of this communication appears on the cover sheet with the correspondence address - Period for Reply					
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).					
Status					
 Responsive to communication(s) filed on 10 December 2007. This action is FINAL. 2b) This action is non-final. Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213. 					
Dispositi	Disposition of Claims				
4) Claim(s) 16-22 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 5) Claim(s) is/are allowed. 6) Claim(s) 16-22 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement.					
Applicati	on Papers		•		
 9) The specification is objected to by the Examiner. 10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner. Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152. 					
Priority u	inder 35 U.S.C. § 119				
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received.					
Attachmen	t(s)				
2) Notic 3) Inform	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO/SB/08) r No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D: 5) Notice of Informal F 6) Other:	ate		

This is in response to the Amendment dated December 10, 2007. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office Action.

Response to Arguments

Specification

The disclosure has been objected to because of minor informalities.

The objection of the disclosure has been withdrawn in view of Applicants' amendment.

Claim Objections

Claims 1 and 7 have been objected to because of minor informalities.

The objection of claims 1 and 7 has been withdrawn in view of Applicants' amendment.

Claim Rejections - 35 USC § 112

Claims **1-11** have been rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

The rejection of claims 1-11 under 35 U.S.C. 112, second paragraph, has been withdrawn in view of Applicants' amendment.

Application/Control Number: 10/720,579

Art Unit: 1795

Claim Rejections - 35 USC § 103

Claims 1-11 have been rejected under 35 U.S.C. 103(a) as being unpatentable over Wolski et al. (US Patent No. 5,834,140) in combination with Yates et al. (US Patent No. 5,863,410) and Merchant et al. (US Patent No. 5,863,666).

The rejection of claims 1-11 under 35 U.S.C. 103(a) as being unpatentable over Wolski et al. in combination with Yates et al. and Merchant et al. has been withdrawn in view of Applicants' amendment. Claims 1-11 have been cancelled.

Response to Amendment

Claim Objections

Claim 20 is objected to because of the following informalities:

Claim 20

line 1, the word -- in -- should be inserted after the word "being".

line 2, the word -- and -- should be inserted after the value "150 g/l,".

line 2, the words -- being in an amount -- should be inserted after the value "150 g/l,".

Appropriate correction is required.

Claim 22 is rejected under 35 U.S.C. 112, second paragraph, as being indefinite

for failing to particularly point out and distinctly claim the subject matter which applicant

regards as the invention.

Claim 22

lines 1-2, recite "said electrolyte has a current density of between 20 and 150

A/dm²."

It is unclear how the electrolyte has a current density. Should the current density

of between 20 and 150 A/dm² be further limiting the negative current and/or positive

current recited in claim 16, line 9?

Claim Rejections - 35 USC § 103

Claims 16-22 are rejected under 35 U.S.C. 103(a) as being unpatentable over

Wolski et al. (US Patent No. 5,834,140) in combination with Yates et al. (US Patent

No. 5,863,410) and **Merchant et al.** (US Patent No. 5,863,666).

Wolski teaches a method for manufacturing an electrodeposited copper foil

comprising:

forming an electrolyte solution 3 (= electrolyte) [col. 3, line 3] containing a (a)

sulfuric acid (col. 6, lines 53-56; and col. 8, lines 45-47) and a copper ion (= from copper

sulfate) [col. 6, lines 53-56; and col. 8, lines 45-47] and a chloride ion (col. 6, lines 14-

29);

Application/Control Number: 10/720,579

Art Unit: 1795

(b) adding an additive to said electrolyte solution, said additive consisting of 6

Page 5

6, lines 10-11; and col. 12, lines 41-43] and 5 ppm to 50 ppm of hydroxyethyl cellulose

ppm to 10 ppm of gelatin (= 0.3 to 35 ppm by weight of gelatin) [col. 5, lines 42-54; col.

(= 0.1 to 15 ppm of hydroxyethyl cellulose) [col. 5, lines 18-30; col. 6, lines 9-10; and

col. 8, line 50];

(c) submerging a rotating drum 2 (= a drum-shaped cathode) and an anode

plate 1 in said electrolyte solution 3, said anode plate having a curved shaped and

spaced by a distance from an outer surface of the drum (= provided to a concentric

circle shape to said cathode 2) [col. 3, lines 3-13; and Fig. 1]; and

(d) applying a negative current (= cathode) to said drum 2 and a positive

current (= anode) to said anode plate 1 so to deposit the copper foil 4 onto said outer

surface of said drum (= to deposit copper on the surface of said cathode) [col. 3, lines 9-

13].

The deposited copper foil has a matte side and a shiny side (col. 3, lines 55-58).

The sulfuric acid is in an amount of 50 to 200 g/l (= 110 g/l of sulfuric acid) and

said copper ion is in an amount of 30 to 150 g/l (= 90 g/l of copper) [col. 8, lines 45-48].

The electrolyte solution is at a temperature of between 20 and 80°C (= 58°C)

[col. 8, Table 1, "Temperature"].

The electrolyte has a current density of between 20 and 150 A/dm² (= 50 A/dm²)

[col. 8, Table 1, "Current density"].

Application/Control Number: 10/720,579

Art Unit: 1795

The method of Wolski differs from the instant invention because Wolski does not disclose the following:

- a. Wherein the additive consists of 0.05 ppm to 20 ppm of bis(sodiumsulfopropyl)disulfide, as recited in claim 16.
- b. Wherein said bis(sodiumsulfopropyl)disulfide is an amount of between 0.5 ppm to 3 ppm, as recited in claim 17.

Wolski teaches that adding <u>3-mercapto-1-propanesulfonate</u> (HS(CH₂)₃SO₃R) in combination of the high molecular weight polysaccharide and/or the low molecular weight glue and a minute amount of the chloride ion to the electrolyte, various characteristics required for a low-profile copper foil for fine patterning can be realized at a high level (col. 6, lines 30-35).

Like Wolski, Yates teaches an electrolytic process for producing copper foil having a low profile surface (col. 1, lines 7-11). Yates teaches that water soluble, sulfonated organic sulfur compounds are important addition agents. Many simple bivalent sulfur organic compounds possess similar ability and thus be useful as additions agents in the electrodeposition of copper. These substances can belong to the group of aliphatic thiols, R-SH, sulfides, R¹-S-R², disulfides R¹-S-S-R², as well as aromatic and heterocyclic thiols, sulfides and disulfides (col. 10, line 55 to col. 11, line 2).

Like Yates, Merchant teaches an electrolytic process for producing copper foil (col. 3, lines 59-62). Merchant teaches that it is critical that the concentration of organic

additives in the electrolyte solution be at least about 0.3 ppm. The organic additive can be selected from the group consisting of saccharin,... *sulfopropyl disulfide*, ... (col. 4, line 64 to col. 5, line 15).

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have modified the additive described by Wolski with wherein the additive consists of 0.05 ppm to 20 ppm of bis(sodiumsulfopropyl)disulfide; and wherein said bis(sodiumsulfopropyl)disulfide is an amount of between 0.5 ppm to 3 ppm because a disulfide would have been a functionally equivalent addition agent to the sulfonated organic sulfur compounds as taught by Yates (col. 10, line 55 to col. 11, line 2), and a sulfopropyl disulfide would have been an obvious disulfide to use in an electrolytic process for producing copper foil as taught by Merchant (col. 4, line 64 to col. 5, line 15), and a bis(sodiumsulfopropyl)disulfide would have been an obvious sulfopropyl disulfide to use in an electrolytic process for producing copper foil because structural relationships may provide the requisite motivation or suggestion to modify known compounds to obtain new compounds.

c. Wherein said matte side has a roughness greater than a roughness of said shiny side, as recited in claim 18.

Wolski teaches that the untreated copper foil, the so-called <u>shiny side</u> which is a surface at the side of contacting with the drum has a <u>relatively smooth surface</u>, but at the reverse surface called <u>a matte side</u>, <u>unevenness is relatively remarkable</u> (col. 3,

lines 55-58). The surface roughness of the untreated copper foil is almost determined by the electrolysis conditions when copper is deposited on the drum-shaped cathode, particularly by an additive to be added to an electrolyte (col. 3, lines 50-54).

The invention as a whole would have been obvious to one having ordinary skill in the art at the time the invention was made because the so-called shiny side which is a surface at the side of contacting with the drum would have had a relatively smooth surface, but at the reverse surface called a matte side, unevenness would have been relatively remarkable as taught by Wolski (col. 3, lines 55-58).

d. Wherein said gelatin has a molecular weight of greater than <u>10000</u>, as recited in claim 19.

Wolski teaches that the commercially available products have weight average molecular weights (Mw) of <u>10,000</u> or less (col. 5, lines 42-54).

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have modified the molecular weight of the gelatin described by Wolski with wherein a molecular weight of the gelatin is above 10000 because a *prima facie* case of obviousness exists where claimed ranges and prior art ranges do not overlap but are close enough that one skilled in the art would have expected them to have the same properties (MPEP § 2144.05(I)).

For example, a Mw of 10,000 versus a Mw of 10,001.

e. Wherein said chloride ion is in an amount of 200 mg/l, as recited in claim 20.

Wolski teaches that in order to produce a low-profiled copper foil in a broad current density range stably, it is preferred to keep the amount in a range of 10 to 60 ppm. *Even when the amount exceeds 60 ppm, low profiling can be effected* (col. 6, lines 14-29).

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have modified the chloride ion described by Wolski with wherein said chloride ion is in an amount of 200 mg/l because when the amount exceeds 60 ppm, low profiling would have still been effected as taught by Wolski (col. 6, lines 14-29).

Furthermore, the concentration of chloride ions is a result-effective variable and one skilled in the art has the skill to calculate the concentration that would have determined the success of the desired reaction to occur, e.g., to produce a low-profiled copper foil in a broad current density range stably (MPEP § 2141.03 and § 2144.05(II)(B)).

RE: REMARKS

Applicants state that this additive is added to the electrolyte solution and contains between 6ppm to 100ppm of a gelatin, 5pmm to 50ppm of hydroxyethyl cellulose, and 0.05ppm to 20ppm of bis(sodiumsulfopropyl)disulfide. Applicant respectfully contends

that none of the prior art references, individually, or in combination, recite an additive that is added to the electrolyte solution in which the additive has this composition.

In response, the Examiner maintains that an additive that is added to the electrolyte solution has such a composition:

Wolski teaches *6ppm to 100ppm* of a gelatin. Wolski teaches an amount of the low molecular weight glue of *0.3 to 35 ppm* by weight (col. 6, lines 10-11; and col. 12, lines 41-43). Since Wolski teaches using gelatin as an alternative to the glue (col. 5, lines 43-47), one having ordinary skill in the art would have been expected to use 0.3 to 35 ppm by weight of the gelatin.

Wolski teaches *5ppm to 50ppm* of hydroxyethyl cellulose. Wolski teaches an amount of the high molecular weight polysaccharide of *0.1 to 15 ppm* (col. 6, lines 9-10; and col. 12, lines 37-41). Since Wolski teaches using hydroxyethyl cellulose (col. 8, line 50), one having ordinary skill in the art would have been expected to use of 0.1 to 15 ppm of hydroxyethyl cellulose.

Yates and Merchant teach *0.05ppm to 20ppm* of bis(sodiumsulfopropyl)disulfide. Merchant specifically teaches *at least about 0.3 ppm* of sulfopropyl disulfide (col. 4, line 64 to col. 5, line 15).

Applicant state that although the Yates patent does disclose the use of the sulfopropyl disulfide component, the Yates patent lacks the gelatin and the hydroxyethyl cellulose.

In response, Yates teaches using gelatin and hydroxyethyl cellulose (HEC). Yates teaches that hydroxyethyl cellulose, compared for purpose of and example, with gelatin, is instrumental in producing micro-topography of the matte side of the foil with a very low peak-count, while reducing peaks height [col. 10, lines 13-22; and col. 11, lines 23-31].

Applicants state that as such, without this additive, the prior art combination would fail to achieve the advantages of the present invention.

Applicants also state that none of the prior art references discloses such a composition nor do they disclose the effect of lowering the roughness of the electrodeposited copper foil. As such, the prior art combination fails to achieve the advantages of the present invention.

In response, the reason or motivation to modify the reference may often suggest what the inventor has done, but for a different purpose or to solve a different problem. It is not necessary that the prior art suggest the combination to achieve the same advantage or result discovered by the Applicants. *In re Linter* 458 F.2d 1013, 173 USPQ 560 (CCPA 1972); *In re Dillon* 919 F.2d 688, 16 USPQ2d 1897 (Fed. Cir. 1990), *cert. denied*, 500 US 904 (1991); and MPEP § 2144.

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP

§ 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Edna Wong whose telephone number is (571) 272-1349. The examiner can normally be reached on Mon-Fri 7:30 am to 4:00 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nam Nguyen can be reached on (571) 272-1342. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only.

For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Edna Wong Primary Examiner Art Unit 1795

EW December 27, 2007